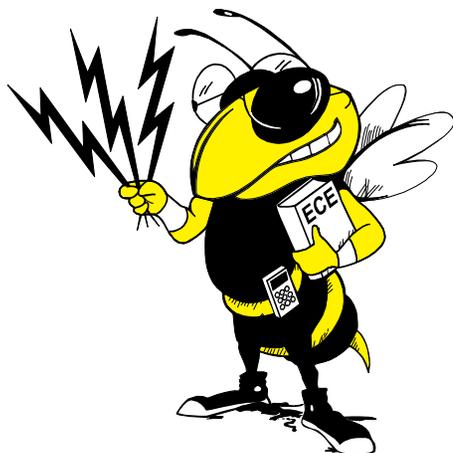




SiGe Research Activities

John D. Cressler

Byers Professor
School of Electrical and Computer Engineering
777 Atlantic Drive, N.W.
Georgia Institute of Technology
Atlanta, GA 30332-0250 USA



cressler@ece.gatech.edu

<http://users.ece.gatech.edu/~cressler/>

Tel (404) 894-5161 / FAX (404) 894-4641

SiGe: Why The Fuss?



- **21st Century Communications Market**

- wireless + wireline + transportation + satellites + radar + other DoD + ...

- ⇒ frequency bands are pushing ever higher

- ⇒ huge market but stringent device requirements

Moral: Need High-Performance Device Technology at Low-Cost!

- **The SiGe HBT**

- first bandgap-engineered Si transistor (nanotechnology!)

- better β , V_A , f_T , f_{max} , NF_{min} than Si BJT

- III-V performance + Si fabrication yield and cost (win-win scenario!)

- 200 GHz SiGe HBTs are a reality! ... 300 GHz is on the way!

- **SiGe HBT BiCMOS Technology**

- very high performance SiGe HBT + best-of-breed Si CMOS

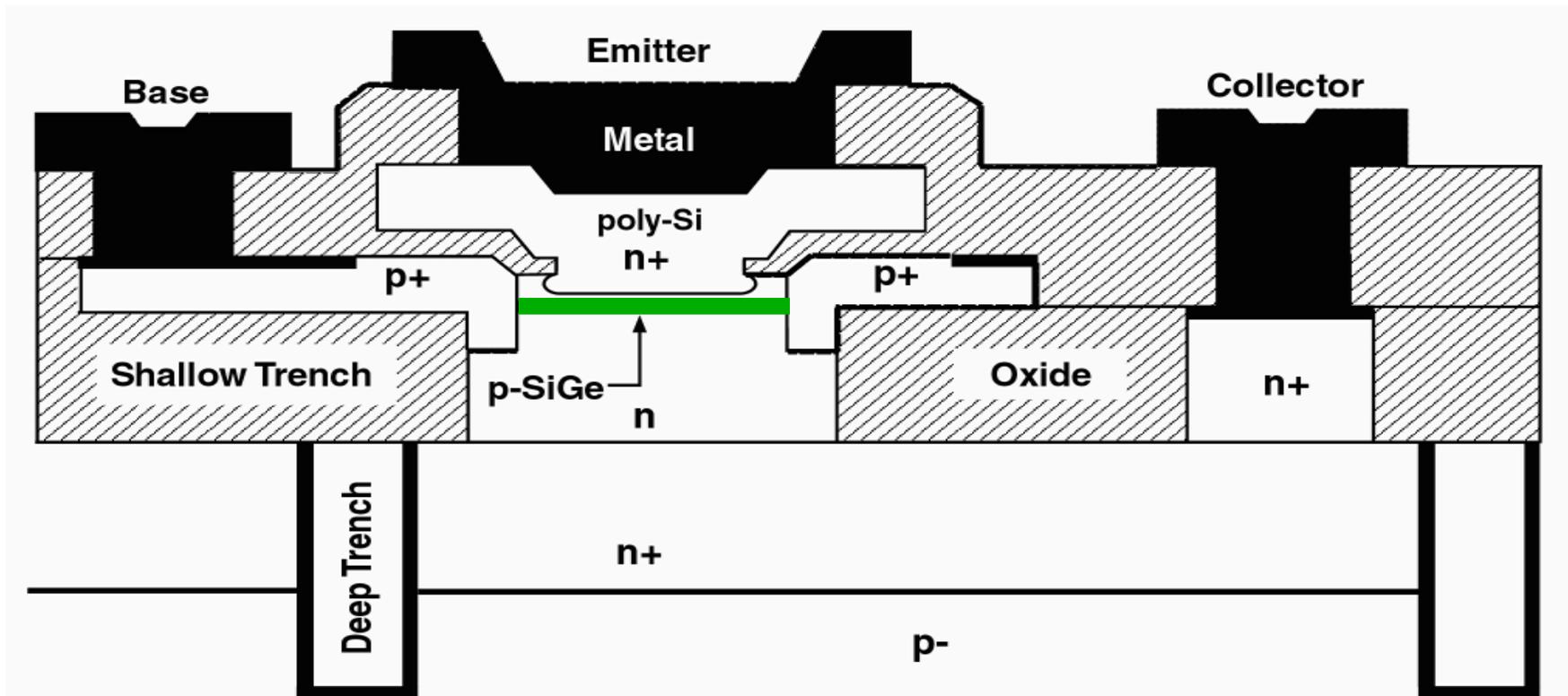
- RF/MMIC + analog + digital + passives for integrated SoC / SiP solutions

- in production (e.g., IBM, Jazz, National, TI, ST, Infineon, Hitachi, etc...)

The SiGe HBT



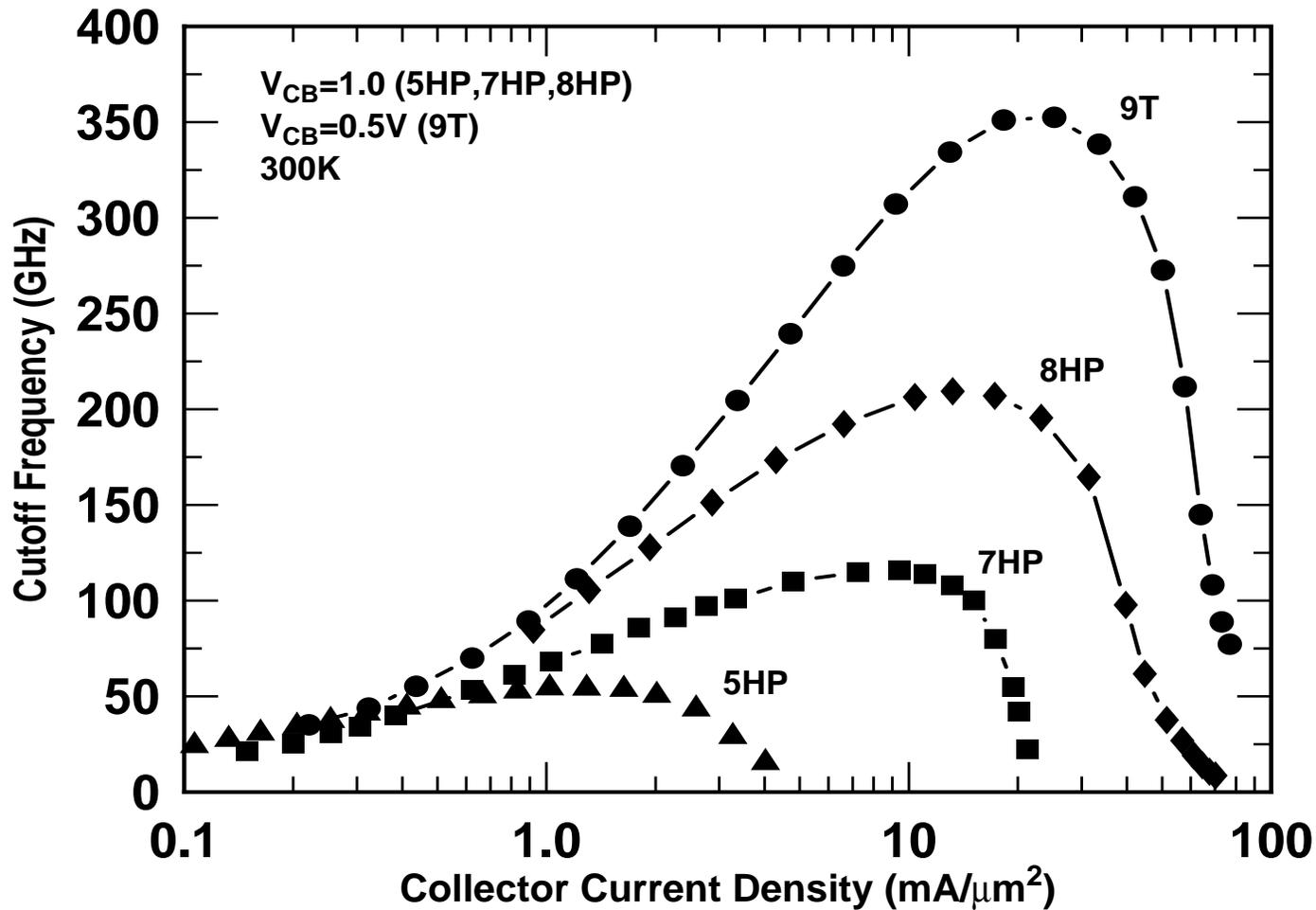
- Conventional Shallow and Deep Trench Isolation + CMOS BEOL
- Unconditionally Stable, UHV/CVD SiGe Epitaxial Base
- 100% Si Fabrication Compatibility
- SiGe HBT + Si CMOS on the same wafer



Performance Trends



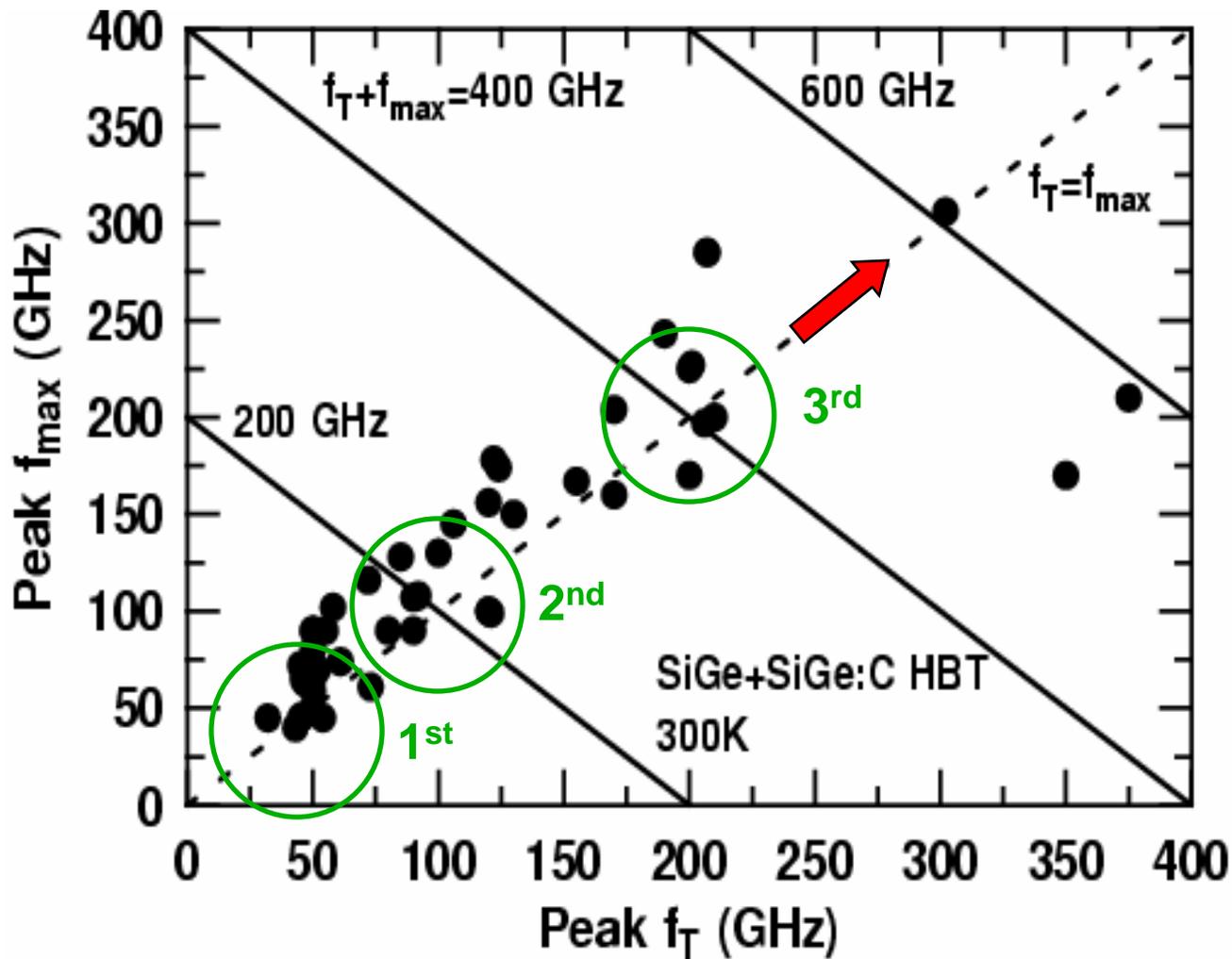
- Unprecedented Device Performance in Si!



Performance Trends



- Generational Evolution (full BiCMOS)



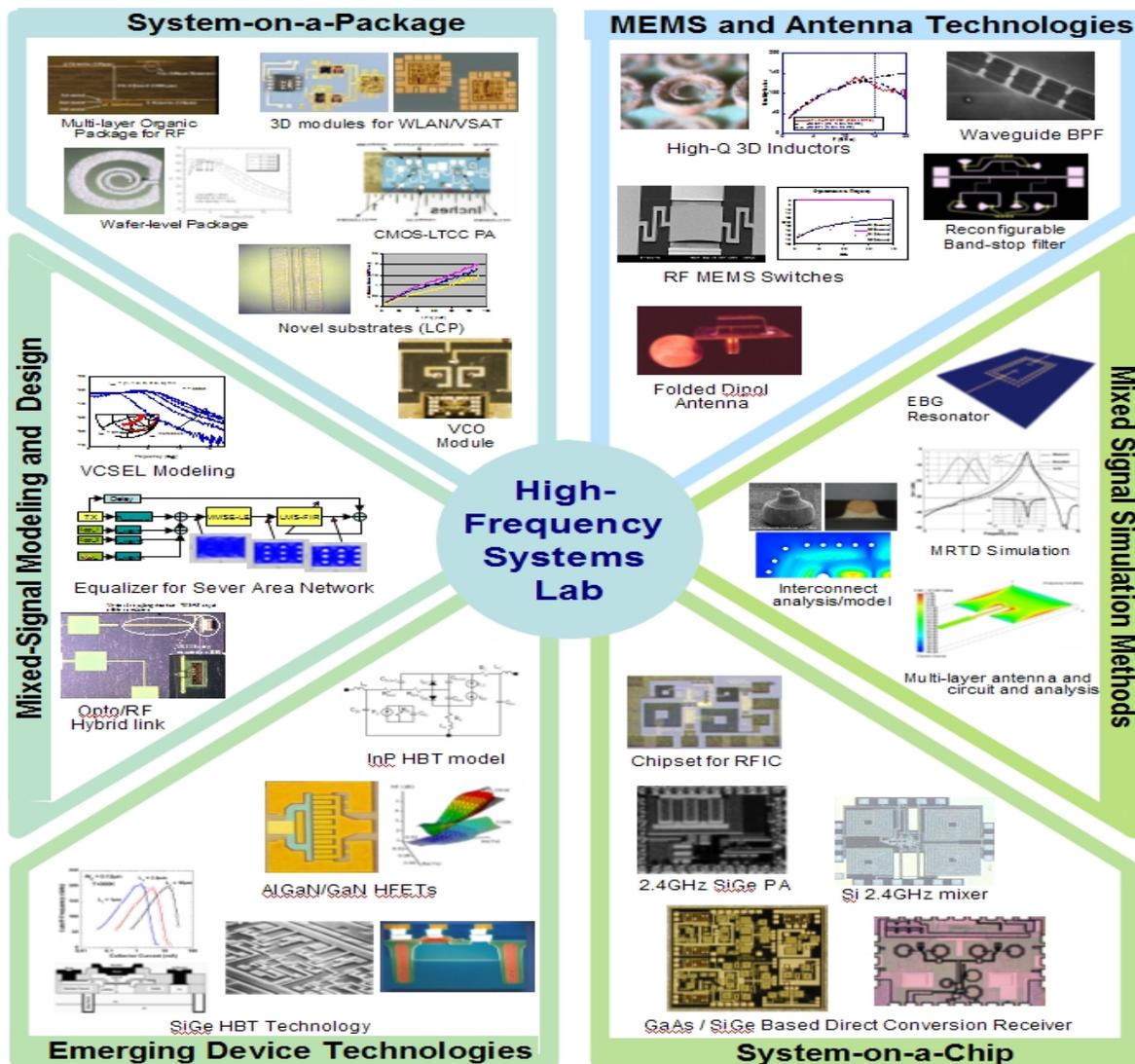


• The Virtues of SiGe HBTs

- high g_m
- low NF_{min}
- very low power dissipation at NF_{min}
- low $1/f$ noise corner + phase noise
- very high output resistance and high βV_A product
- very high frequency response (can trade f_T for power!)
- high power gain
- good linearity
- potential for operation at cryogenic temperatures / high temperatures
- all device parameters are in principle tunable!
- high levels of integration + passives + t-lines
- built-in total dose radiation tolerance
- CMOS is already on-board to use where needed / beneficial

Moral: SiGe is a Natural for Mixed-Signal!

The 5th Floor Team: Professors Laskar, Tentzeris, Papapolymerou, and Cressler Theme: “Devices-to-Systems”



Research Specialties:

- *Device / Circuit Characterization*
- *Compact Modeling*
- *Device Optimization*
- *Analog / Digital / RF Circuit Design*
- *RFIC / MMIC Design*
- *Advanced Integrated Modules*
- *Packaging / Interconnects*
- *mm-wave Circuits / Modules*
- *Antennas*
- *Embedded Passives*
- *RF MEMS*
(Switches, Tunable Filters ...)
- *Computational Electromagnetics*
- *Transmission Lines*
- *Mixed-signal ICs / Systems for High-Speed Digital Applications*



High-Frequency Systems Lab - Research Facilities -

>\$10 M

The 5th Floor Team: Professors Laskar, Tentzeris, Papapolymerou, and Cressler



- Exhaustive Device and Circuit Characterization Capability
- dc – 100 GHz; 4K to 500C; fA to A, uV to kV
- Lab Manager Oversight
- Web-based Instrument Scheduling

Research Program

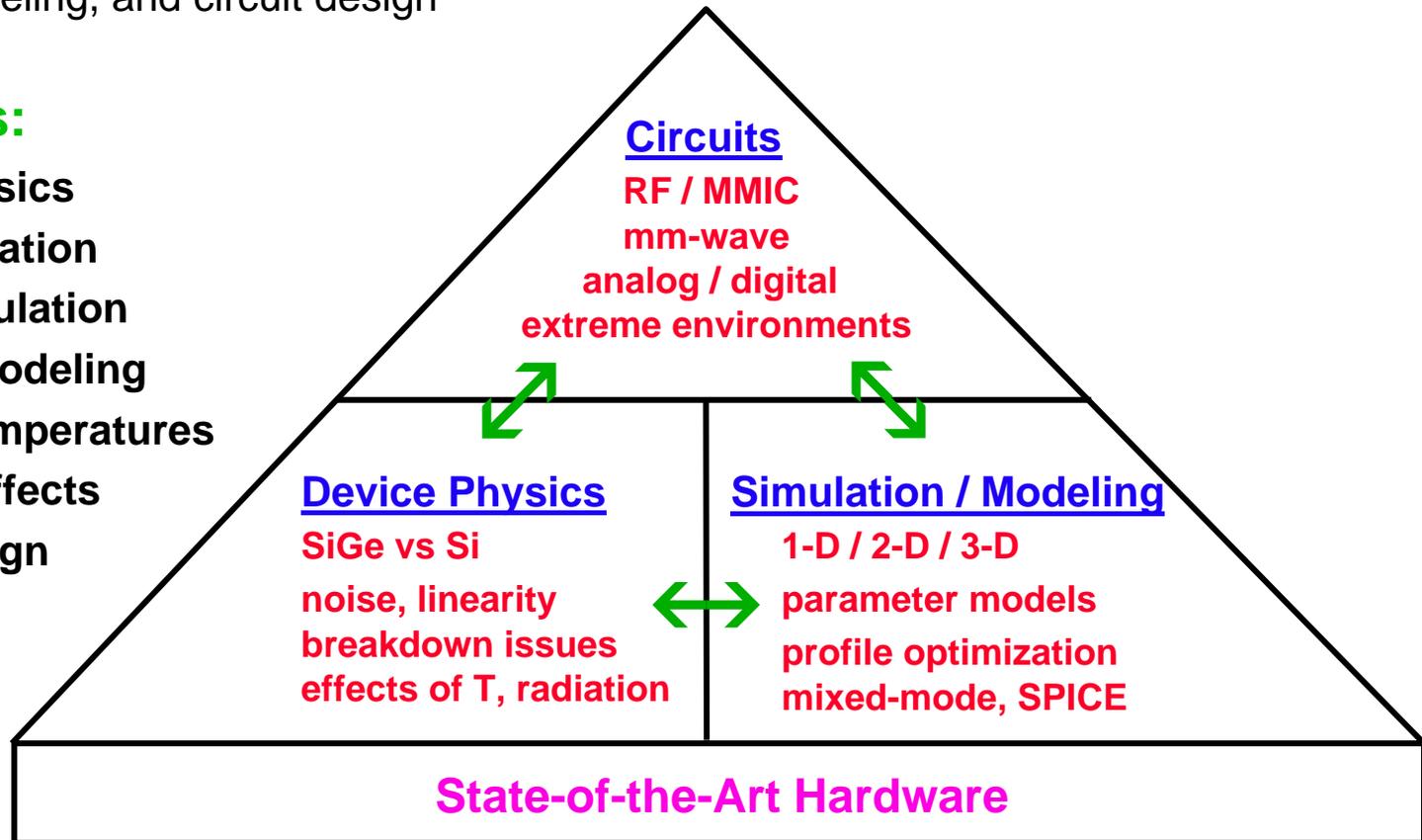


- **Focus:** “SiGe Devices and Circuits”

Fundamental device physics, fabrication, device and circuit characterization, RF / microwave / mm-wave properties of devices, profile optimization for specific circuit / system applications, device-to-circuit interactions, device simulation, compact modeling, and circuit design

- **Specialties:**

- device physics
- characterization
- device simulation
- compact modeling
- extreme temperatures
- radiation effects
- circuit design



New Opportunities



- **SiGe Millimeter-wave Communications Systems**
 - 60 GHz ISM band (> 1Gb/sec wireless links)
 - wavelength at mm-wave enables monolithic antennae integration
- **SiGe Radar Systems**
 - defense theater radar (10 GHz)
 - automotive radar (24 GHz, 77 GHz, 94 GHz)
- **SiGe Core Analog Functions**
 - data converters (10Gb/sec 8 bit ADC!)
 - references, op-amps, drivers, etc.
- **SiGe Extreme Environment Electronics**
 - cryogenic temperatures (e.g., to 77K or 4K)
 - radiation (e.g., space)
 - high-temperatures (e.g., to 200C or 300C)



• SiGe Devices and Circuits

- Profile optimization issues, stability limits, and new device physics phenomena
- RF / microwave / mm-wave understanding of noise and linearity
- Understanding device-to-circuit interactions
- Radiation effects in devices and circuits (total dose + SEU + RHBD)
- Breakdown limits and voltage constraints and their impact on circuit design
- 1/f noise physics, microscopic noise simulation, and its up-conversion to phase noise
- Reliability physics and geometrical scaling / thermal issues
- New de-embedding techniques for mm-wave characterization of devices / circuits
- 2-D / 3-D device-level simulation and compact circuit modeling issues
- Cryogenic operation of devices and circuits
- **Circuit Design Thrusts:**
 - transceiver building blocks (high RF to mm-wave)
 - SiGe radar (X-band and up)
 - high-speed analog (ADC, op-amps, etc.)
 - radiation-hardened digital logic (SEU)
 - specialized circuits (UWB LNA, cryogenic amps, etc.)

• Other Stuff

- SiC devices for high-power / high-temperature switching systems, SOI CMOS, etc.

• Personnel

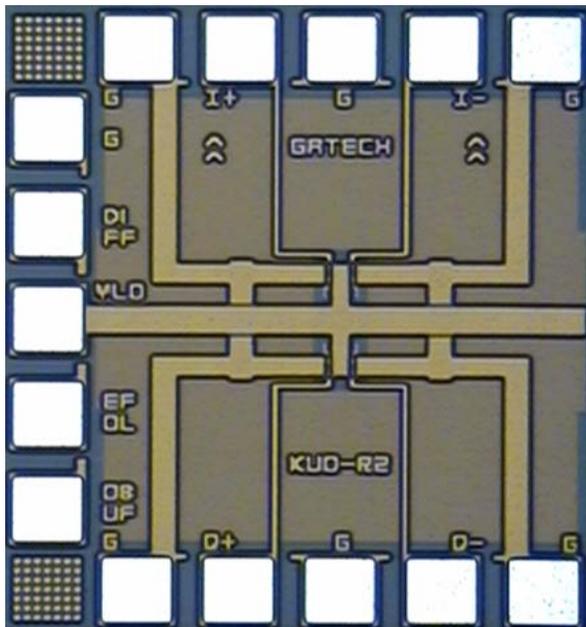
- 15 PhD, 3 MS, 2 post-doc, 4 UG

Cressler – SiGe Circuits

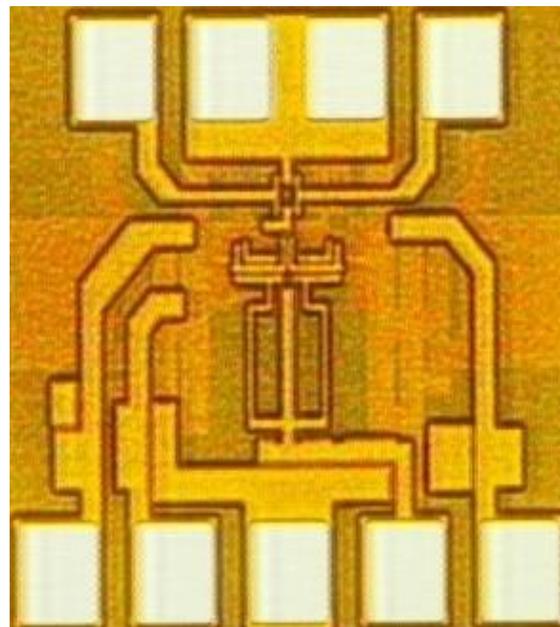


- **Major Circuit Design Thrusts in Cressler's Team:**

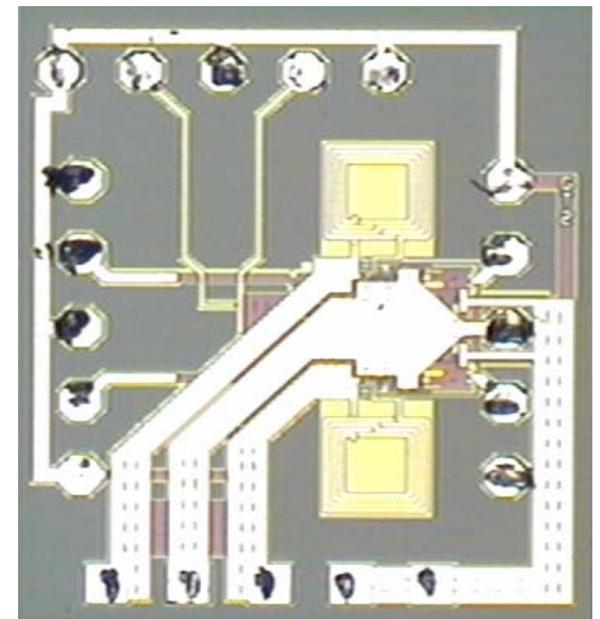
- transceiver building blocks (high RF to mm-wave)
- SiGe monolithic radar T/R modules (X-band to W-band)
- high-speed data converters (ADC, DAC, opamps, references, etc.)
- radiation-hardened mixed-signal circuits (RHBD for SEU + TID)
- specialized circuits (UWB, cryogenic circuits, switches, T-lines, etc.)



21 GHz Oscillator

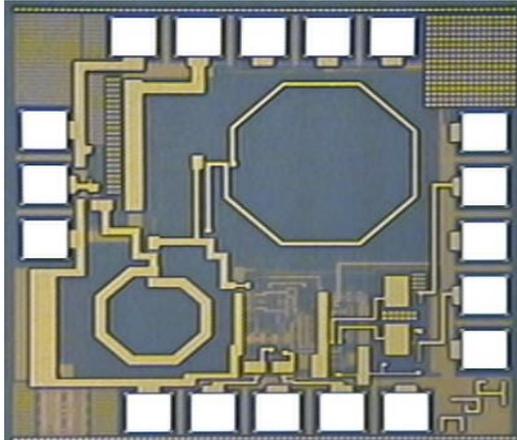


33 GHz VCO

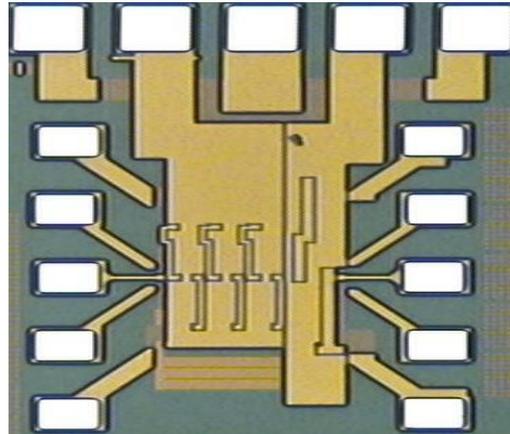


8b 12 GS/sec T/H Amp

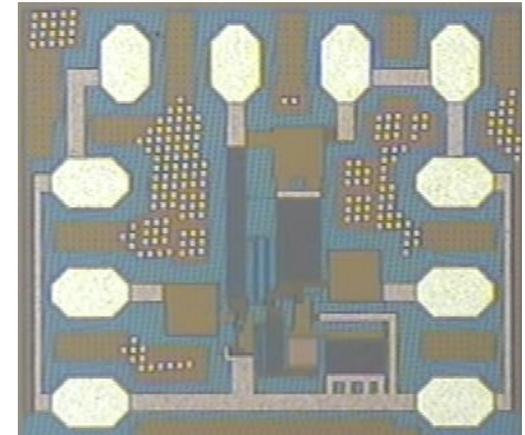
Cressler – SiGe Circuits



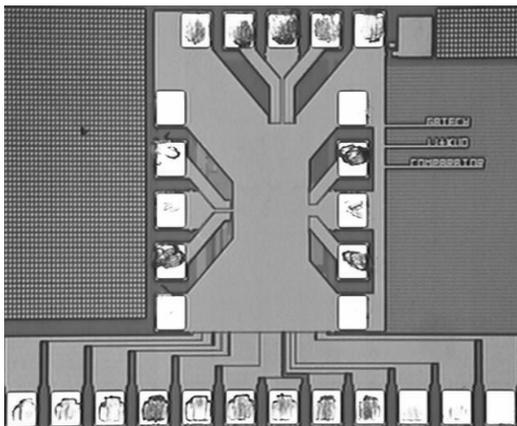
10 GHz Down-Mixer



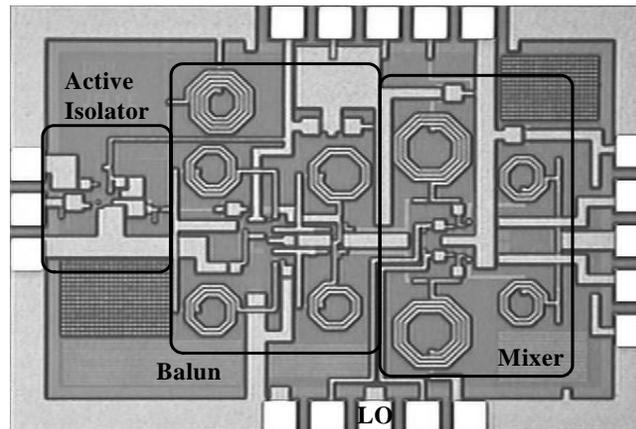
24 GHz Limiting Amp



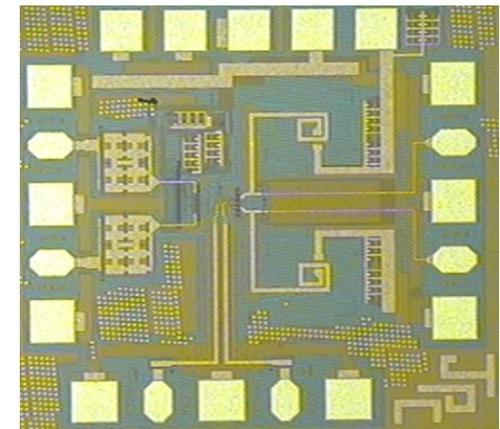
3-10 GHz UWB LNA



7b 18 GHz Comparator



5 GHz Active Mixer with Isolator



28 GHz Up-Mixer

My Gang at Georgia Tech

Georgia Institute
of Technology

